

advanced

60 V

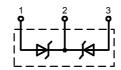
0.68 V

Schottky

High Performance Schottky Diode Low Loss and Soft Recovery Common Cathode

Part number (Marking on product)

DSA 20 C 60PN

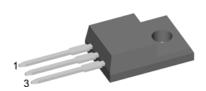


Features / Advantages:

- Very low Vf
- Extremely low switching losses
- Low Irm-values
- Improved thermal behaviour
- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching
- Low losses

Applications:

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters



Package:

 $V_{RRM} =$

 $I_{FAV} = 2x \cdot 10 A$

TO-220FPAB

- Industry standard outline
- Plastic overmolded tab for electrical isolation
- Epoxy meets UL 94V-0
- RoHS compliant

Ratings

Symbol	Definition	Conditions		min.	typ.	max.	Unit
V _{RRM}	max. repetitive reverse voltage		T _{VJ} = 25 °C			60	V
I _R	reverse current	V _R = 60 V	T _{VJ} = 25 °C			0.3	mA
		$V_R = 60 V$	T_{VJ} = 125 °C			3	mA
V _F	forward voltage	I _F = 10 A	$T_{VJ} = 25 ^{\circ}\text{C}$			0.85	V
		$I_F = 20 A$				0.95	V
		I _F = 10 A	T _{VJ} = 125°C			0.68	V
		$I_F = 20 A$				0.78	V
I _{FAV}	average forward current	rectangular, d = 0.5	$T_{\rm C}$ = 140 °C			10	Α
V _{F0}	threshold voltage slope resistance $T_{VJ} = 175 ^{\circ}\text{C}$				0.44	V	
						15	mΩ
R_{thJC}	thermal resistance junction to case					4.50	K/W
T _{vJ}	virtual junction temperature			-55		175	°C
P _{tot}	total power dissipation		T _C = 25 °C			35	W
I _{FSM}	max. forward surge current	$t_p = 10 \text{ ms } (50 \text{ Hz}), \text{ sine}$	$T_{VJ} = 45 ^{\circ}\text{C}$			100	Α
C _J	junction capacitance	$V_R = V; f = 1 MHz$	$T_{VJ} = 25 ^{\circ}C$				pF
Eas	non-repetitive avalanche energy	$I_{AS} = A; L = 100 \mu\text{H}$	$T_{VJ} = 25 ^{\circ}C$			tbd	mJ
I _{AR}	repetitive avalanche current	$V_A = 1.5 \cdot V_R \text{ typ.}; f = 10 \text{ kHz}$				tbd	Α

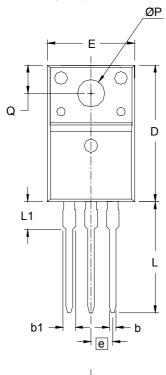


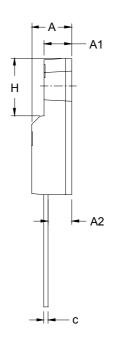
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				Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit	
I _{RMS}	RMS current	per pin*			35	Α	
R _{thCH}	thermal resistance case to I	heatsink		0.50		K/W	
M_{D}	mounting torque		0.4		0.6	Nm	
F _c	mounting force with clip		20		60	N	
T _{stg}	storage temperature		-55		150	°C	
Weight				2		g	

^{*} Irms is typically limited by: 1. pin-to-chip resistance; or by 2. current capability of the chip.
In case of 1, a common cathode/anode configuration and a non-isolated backside, the whole current capability can be used by connecting the backside.

Outlines TO-220FPAB





SYM	INCHES		MILLIMETERS		
2114	MIN	MAX	MIN	MAX	
Α	.177	.193	4.50	4.90	
A1	.092	.108	2.34	2.74	
A2	.101	.117	2.56	2.96	
b	.028	.035	0.70	0.90	
b1	.050	.058	1.27	1.47	
С	.018	.024	0.45	0.60	
D	.617	.633	15.67	16.07	
E	.392	.408	9.96	10.36	
е	.100 BSC		2.54 BSC		
Н	.255	.271	6.48	6.88	
L	.499	.523	12.68	13.28	
L1	.119	.135	3.03	3.43	
ØΡ	.121	.129	3.08	3.28	
Q	.126	.134	3.20	3.40	